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FAIRCHILD SEMICONDUCTOR®

December 2013

FDPF17N60NT

N-Channel UniFET™ II MOSFET

600 V, 17 A, 340 mΩ

Features

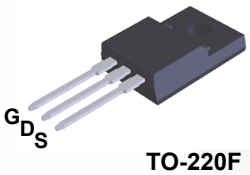
- $R_{DS(on)}$ = 290 mΩ (Typ.) @ V_{GS} = 10 V, I_D = 8.5 A
- Low Gate Charge (Typ. 48 nC)
- Low C_{rss} (Typ. 23 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- RoHS Compliant

Applications

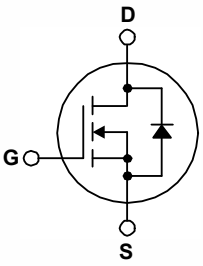
- LCD/LED/PDP TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFET™ II MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on advanced planar stripe and DMOS technology. This advanced MOSFET family has the smallest on-state resistance among the planar MOSFET, and also provides superior switching performance and higher avalanche energy strength. In addition, internal gate-source ESD diode allows UniFET II MOSFET to withstand over 2kV HBM surge stress. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.



TO-220F



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol	Parameter		FDPF17N60NT	Unit
V_{DSS}	Drain to Source Voltage		600	V
V_{GSS}	Gate to Source Voltage		±30	V
I_D	Drain Current	- Continuous (T_C = 25°C)	17*	A
		- Continuous (T_C = 100°C)	10.2*	
I_{DM}	Drain Current	- Pulsed (Note 1)	68*	A
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	838	mJ
I_{AR}	Avalanche Current	(Note 1)	17	A
E_{AR}	Repetitive Avalanche Energy	(Note 1)	24.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	10	V/ns
P_D	Power Dissipation	(T_C = 25°C)	62.5	W
		- Derate Above 25°C	0.5	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T_L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FDPF17N60NT	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	2.0	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

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Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDPF17N60NT	FDPF17N60NT	TO-220F	Tube	N/A	N/A	50 units

Electrical Characteristics $T_C = 25^oC$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
BV_{DSS}	Drain to Source Breakdown Voltage	I_D = 250 μA, V_{GS} = 0 V, T_C = 25°C	600	-	-	V
ΔBV_{DSS} / ΔT_J	Breakdown Voltage Temperature Coefficient	I_D = 250 μA, Referenced to 25°C	-	0.8	-	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 600 V, V_{GS} = 0 V	-	-	1	μA
		V_{DS} = 480 V, V_{GS} = 0 V, T_C = 150°C	-	-	10	
I_{GSS}	Gate to Body Leakage Current	V_{GS} = ±30 V, V_{DS} = 0 V	-	-	±100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 250 μA	3.0	-	5.0	V
$R_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10 V, I_D = 8.5 A	-	0.29	0.34	Ω
g_{FS}	Forward Transconductance	V_{DS} = 20 V, I_D = 8.5 A	-	21	-	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1 MHz	-	2285	3040	pF
C_{oss}	Output Capacitance		-	310	410	pF
C_{rss}	Reverse Transfer Capacitance		-	23	35	pF
$Q_{g(tot)}$	Total Gate Charge at 10V	V_{DS} = 480 V I_D = 17 A, V_{GS} = 10 V (Note 4)	-	48	65	nC
Q_{gs}	Gate to Source Gate Charge		-	13	-	nC
Q_{gd}	Gate to Drain “Miller” Charge		-	20	-	nC
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 300 V, I_D = 17 A, V_{GS} = 10 V, R_G = 25 Ω (Note 4)	-	48	106	ns
t_r	Turn-On Rise Time		-	79	168	ns
$t_{d(off)}$	Turn-Off Delay Time		-	128	266	ns
t_f	Turn-Off Fall Time		-	62	134	ns
Drain-Source Diode Characteristics						
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	74	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	68	A
V_{SD}	Drain to Source Diode Forward Voltage	V_{GS} = 0 V, I_{SD} = 17 A	-	-	1.4	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0 V, I_{SD} = 17 A, dI_F/dt = 100 A/μs	-	575	-	ns
Q_{rr}	Reverse Recovery Charge		-	7.2	-	μC

Notes:

1. Repetitive rating: pulse-width limited by maximum junction temperature.
2. L = 5.8 mH, I_{AS} = 17 A, V_{DD} = 50 V, R_G = 25 Ω, starting T_J = 25°C.
3. I_{SD} ≤ 17 A, di/dt ≤ 200 A/μs, V_{DD} ≤ BV_{DSS}, starting T_J = 25°C.
4. Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

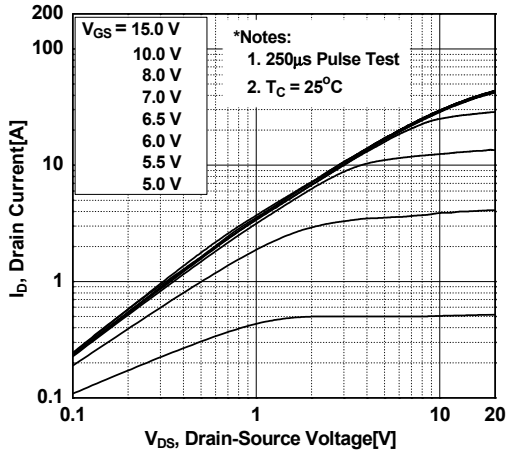


Figure 2. Transfer Characteristics

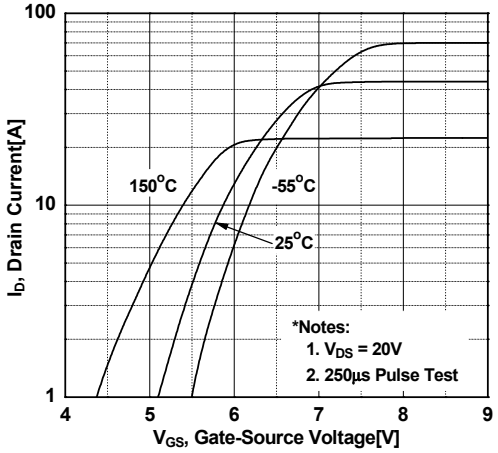


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

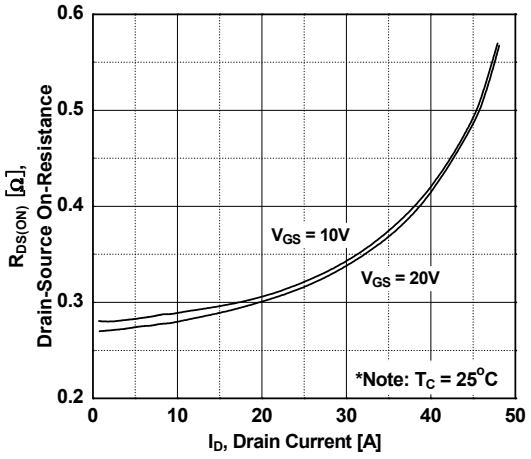


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

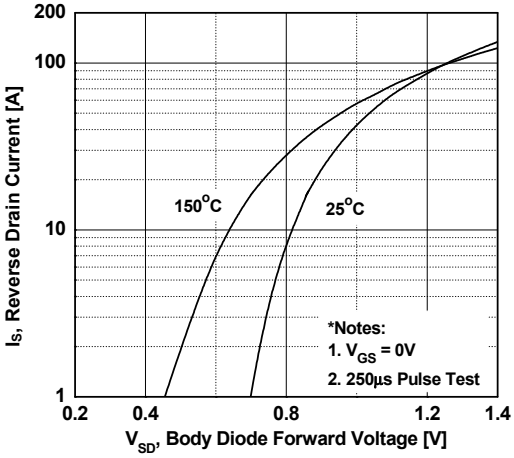


Figure 5. Capacitance Characteristics

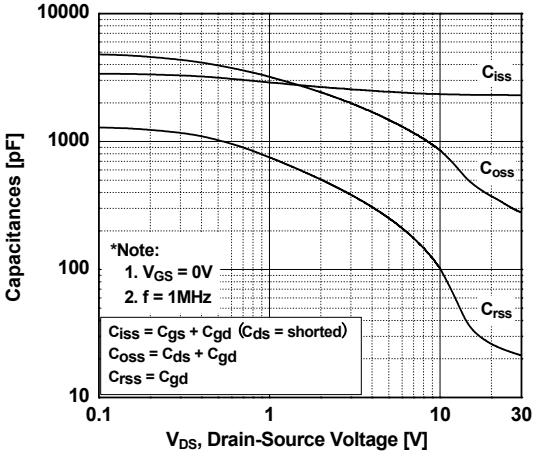
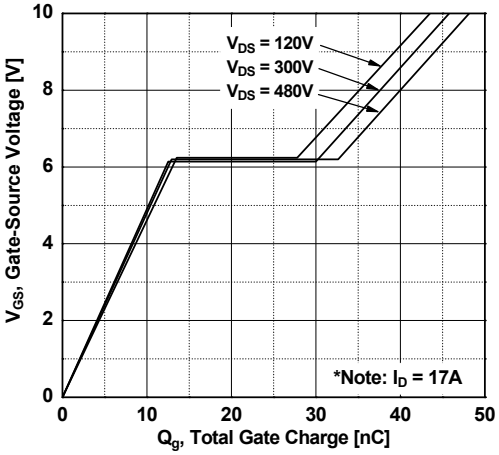


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

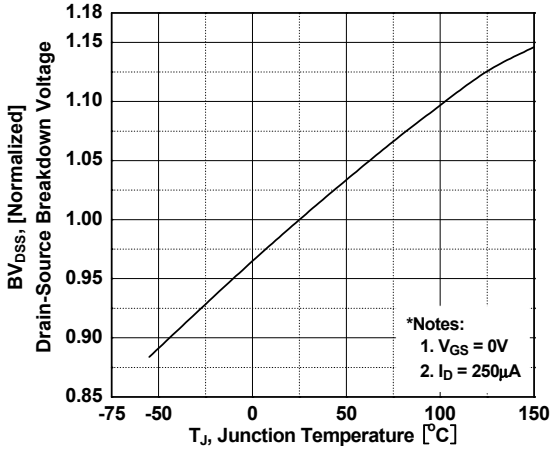


Figure 8. On-Resistance Variation vs. Temperature

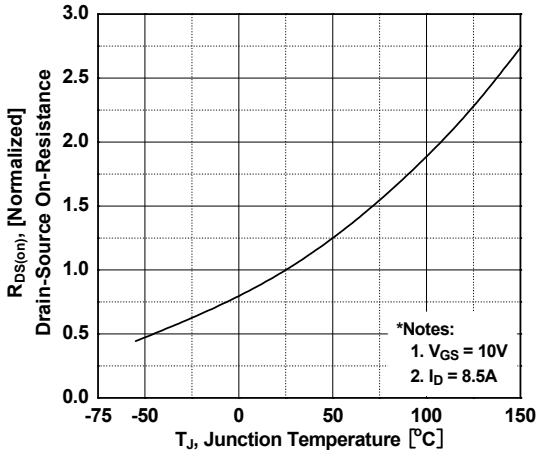


Figure 9. Maximum Safe Operating Area

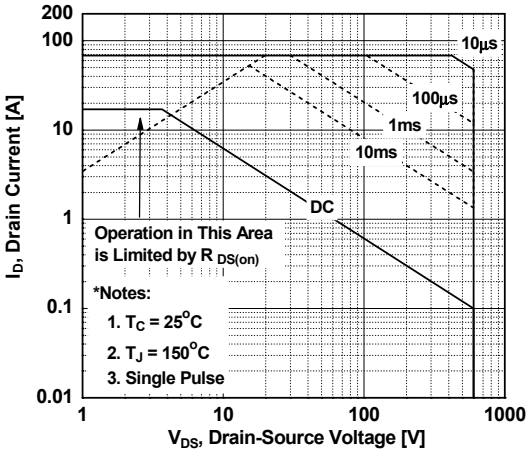


Figure 10. Maximum Drain Current vs. Case Temperature

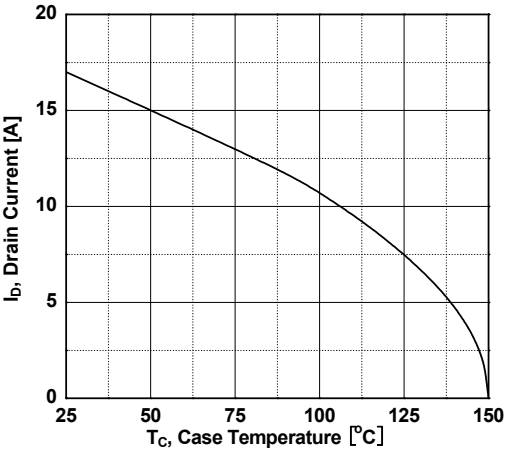
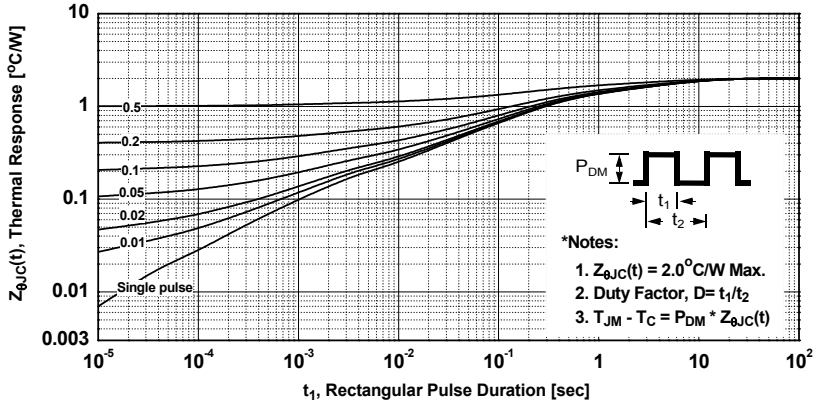


Figure 11. Transient Thermal Response Curve



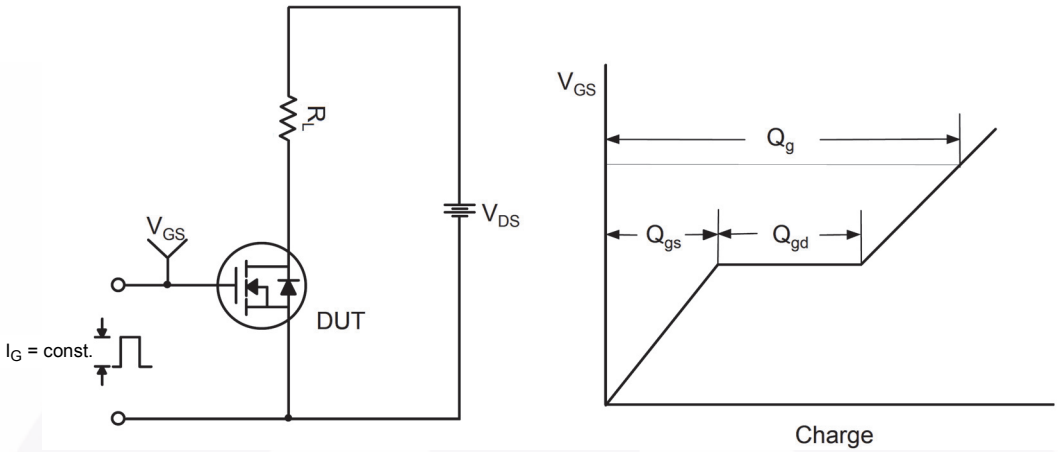


Figure 12. Gate Charge Test Circuit & Waveform

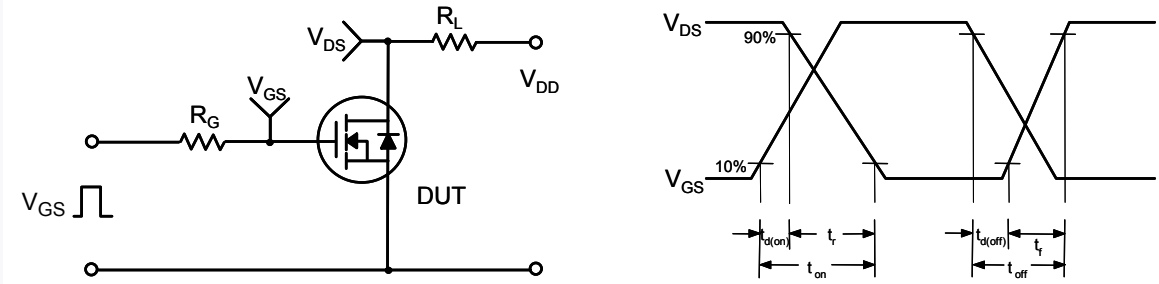


Figure 13. Resistive Switching Test Circuit & Waveforms

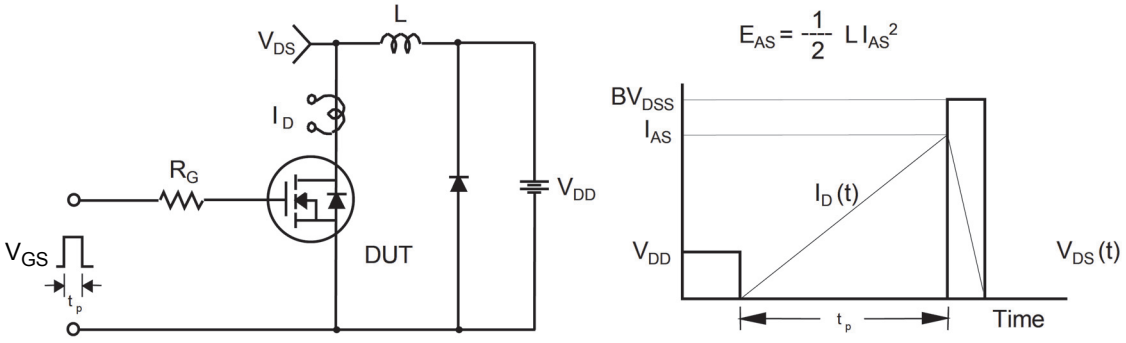


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

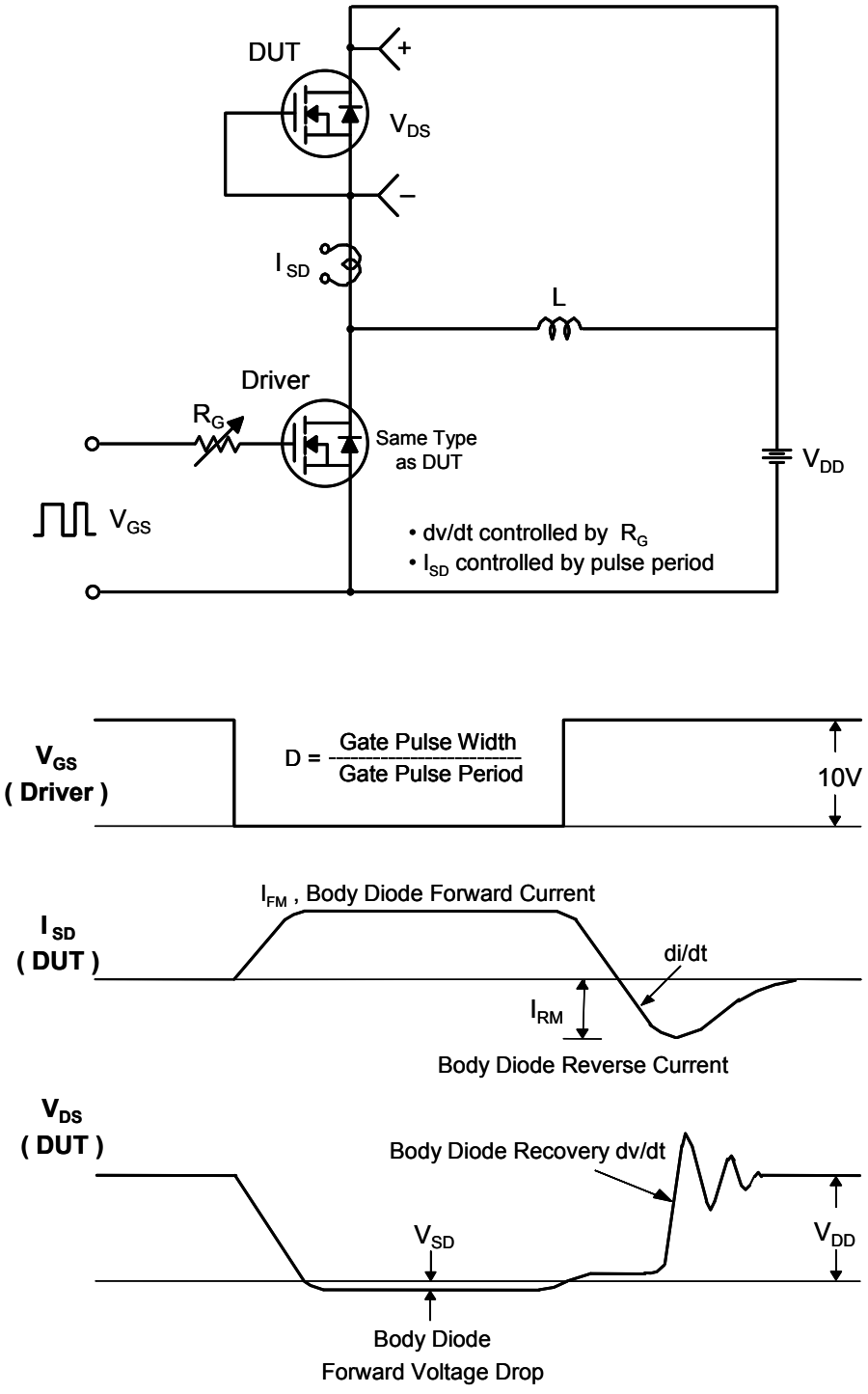


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

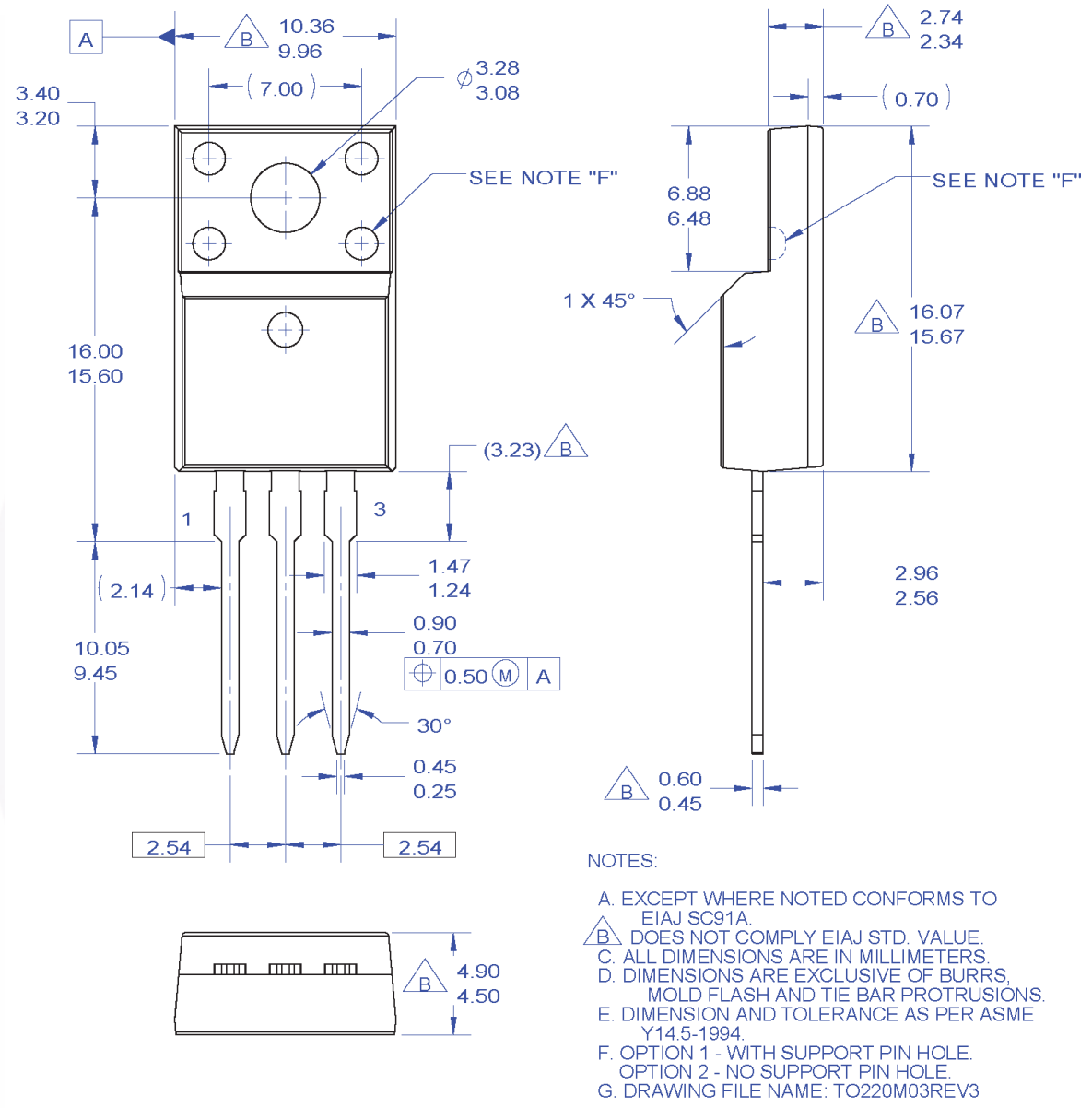


Figure 16. TO220, Molded, 3-Lead, Full Pack, EIAJ SC91, Straight Lead

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